

Effects of PV Module Soiling on Glass Surface Resistance and Potential-Induced Degradation

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1. Goals

- Determine applicability of transmission line method (TLM) to evaluate sheet resistance of soils on module glass
- Evaluate various soils on glass for changes in surface resistance and their ability to promote potential-induced degradation with humidity (PID)
- Evaluate PID characteristics, rate, and leakage current increases on full-size mc-Si modules associated with a conductive soil on the surface

2. Introduction & Background

- PID is a critical degradation mode sometimes observed in crystalline silicon PV modules
- Factors promoting PID include increased conduction paths from the active cell circuit to ground
- Conductive soiling on glass may act as a conductive path from the glass face to the grounded metal module frame or edge clips
- Soiling may further trap or react with moisture and increase conductivity on the module face, promoting ionic conduction and PID
- TLM is commonly used to determine sheet resistance of semiconductor films independent of film lateral dimensions
- TLM is hence applied to evaluate the resistivity of soil films on module glass as function of relative humidity

3. Apparatus

- Multi-probe board, 4 wire measurements
- Voltage power supply, current sense circuits
- Resolution of the apparatus: 5×10^{-9} A, but surface conductivity of the probe holder board at 95% RH led to a background current of 1.5×10^{-8} A
- Multi-probe board connected to sample and placed in an environmental chamber



4. Experiment

A) 162-cm² Square Starphire (low-iron) untextured glass TLM samples

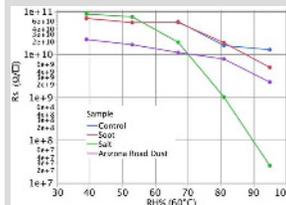
- Conductor stripes: 3M Electrically Conductive Aluminum Tape #3302, 15.25 cm x 1 cm, 0.25, 0.50, 1.5, and 2.0 cm edge-to-edge
- Glass coupons weighed prior and post soil deposition to determine the mass loading
- Simulants of common soils applied:
 - Arizona road dust: A2 line grade, Powder Technology, Inc.
 - Sea salt: ASTM D-1141-S2, Lake Products Co., Inc.
 - Soot: in-house formulation, consisting of 92% carbon black [Vulcan XC-723], 5.3% diesel particulate matter [NIST Catalog No. 2975], 2.8% unused 10W30 motor oil, 0.1% β -pinene [Catalog No. AC13127-2500, Acros Organics]] suspended in deionized H₂O
- Mass loading: 2.75 ($\sigma = 0.87$) g/m²
- 60° C, 100 V, step stress of relative humidity: 39% to 95%
- Samples used just once due to ion migration and AI corrosion

B) 60 cell mc-Si modules

- Sea salt mass loading: 25 g/m²
- 60° C, -1000 V, step stress of relative humidity 25%, 65%, 85%, and 95%

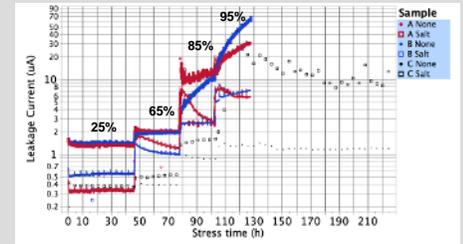
5. Results

A) Sheet resistance of various soils on glass and an unsoiled control as a function of relative humidity at 60° C



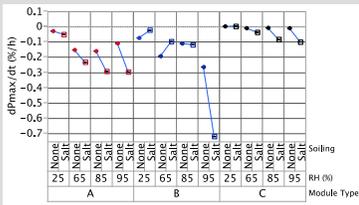
- Arizona road dust:**
- Lower sheet resistance compared to the control
 - humidity-independent but elevated leakage current suggest increased PID in a low-humidity environment
- Soot:**
- Did not show significant conductivity over the unsoiled control
 - Different soot and other carbon-containing compounds may have differing results
- Sea Salt:**
- 3.5 order of magnitude decrease in resistance with relative humidity increase from 39% to 95%.

B) Leakage current measured from three pairs of module types, one in each pair with sea salt on the surface, as a function of RH



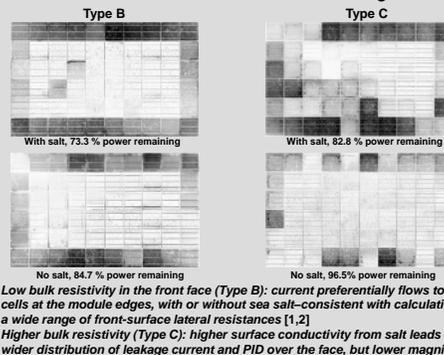
- Leakage current measured on the modules with salt were a factor of two to ten times higher than the modules without sea salt
- At the 85% and 95% RH levels, the modules with sea salt applied show relatively unstable leakage current as a function of time, usually increasing
- Type C module package is more resistive

PID rate at P_{max} for three module types at 60° C with and without sea salt applied as a function of relative humidity (determined at end of RH dwell)



- Increased conductivity of sea salt induces greater PID rate at higher humidity
- Most resistive module package (Type C) degraded the least

Post-stress test electroluminescence images



- Low bulk resistivity in the front face (Type B): current preferentially flows to the cells at the module edges, with or without sea salt—consistent with calculations for a wide range of front-surface lateral resistances [1,2]
- Higher bulk resistivity (Type C): higher surface conductivity from salt leads to wider distribution of leakage current and PID over the face, but lower magnitude

6. Summary & Conclusions

- Soiling determined to be a factor promoting PID.
- Arizona road dust showed a decreased resistivity at low relative humidity, but relatively little humidity dependence.
- Sea salt showed an important decrease in resistivity and 3.5 orders of magnitude lower sheet resistance at 95% RH. PID risk due to soiling that causes increased module surface conductivity.
- Sea salt on 60-cell mc-Si commercial modules promoted increases in leakage current, especially at 85% and 95% RH, leading to increased PID.
- Distribution of leakage current and PID depends on module front bulk resistance.
- Because of these results, examination of other soil types and further investigation into time-dependent effects are indicated.

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[1] S. Pingel, et al. "The local potential distribution as driver of PID & 'Live PID Monitoring' method," in 29th European PV Solar Energy Conference and Exhibition, p. 2335, 2014.

[2] N. Shiradkara, E. Schneller, and N.G. Dhere, "Finite element analysis based model to study the electric field distribution and leakage current in PV modules under high voltage bias," Proc. of SPIE, Vol. 8825, 8250G-2, 2013.